

20 m Ω , **2.0 A Fast Turn On** Load Switch with Discharge

General Description

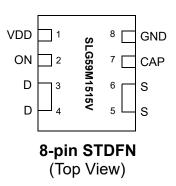
The SLG59M1515V is a 20 m Ω 2.0 A single-channel load switch with configurable slew rate control. The device can enable fast power rail turn on with big cap loading. Internal circuit limits max inrush current to prevent device damage. The product is packaged in an ultra-small 1.0x1.6mm package.

Features

- 1.0 x 1.6 x 0.55 mm STDFN 8L package (2 fused pins for drain and 2 fused pins for source)
- Logic level ON pin capable of supporting 0.85 V CMOS Logic
- · Discharged Load when off
- Fast Turn On time
 - + 25 $\mu s,$ Tune Cap = 0.1 nF, C_{LOAD} = 1 μF @ 100 mA
 - 95 μ s, Tune Cap = 0.5 nF, C_{LOAD} = 10 μ F @ 2.5 A
- Low RDS_{ON}while supporting 2.0 A

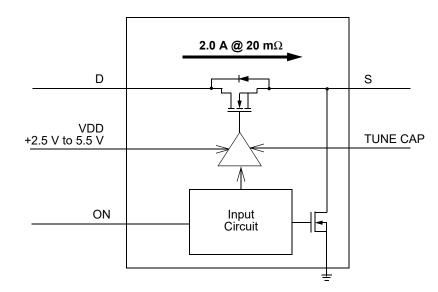
 - 20 m Ω , V_{DD} = 5 V, V_D = 1 V 27.5 m Ω , V_{DD} = 3.3 V, V_D = 1 V
- Pb-Free / Halogen-Free / RoHS compliant
- Operating Temperature: -40 °C to 85°C
- Operating Voltage: 2.5 V to 5.5 V
- Power Rail Switching V_D = 0.85 V to V_D = V_{DD} 1.5 V

Pin Configuration



Applications

- · Fast Turn On/Off power rail switching with big Cap loading
- Frequent wake & sleep power cycle
- · Mobile devices and portable devices



Block Diagram



Pin Description

Pin #	Pin Name	Туре	Pin Description
1	VDD	PWR	VDD power for load switch control (2.5 V to 5.5 V)
2	ON	Input	Turns MOSFET ON (4 M Ω pull down resistor) CMOS input with VIL < 0.3 V, VIH > 0.85 V
3	D	MOSFET	Drain of Power MOSFET (fused with pin 4)
4	D	MOSFET	Drain of Power MOSFET (fused with pin 3)
5	S	MOSFET	Source of Power MOSFET (fused with pin 6)
6	S	MOSFET	Source of Power MOSFET (fused with pin 5)
7	CAP	CAP	Tuning Cap
8	GND	GND	Ground

Ordering Information

Part Number	Туре	Production Flow
SLG59M1515V	STDFN 8L	Industrial, -40 °C to 85 °C
SLG59M1515VTR	STDFN 8L (Tape and Reel)	Industrial, -40 °C to 85 °C



Absolute Maximum Ratings

Description	Conditions	Min.	Тур.	Max.	Unit
Power Supply			-	7	V
Storage Temperature		-65	-	150	°C
ESD Protection	Human Body Model	2000	-		V
Package Power Dissipation			-	0.4	W
	For no more than 20 μs with 1% duty cycle		-	25.0	Α
Peak Current from Drain to Source	For no more than 50 μs with 1% duty cycle		-	12.5	Α
	For no more than 1 ms with 1% duty cycle		-	3.5	Α
	Power Supply Storage Temperature ESD Protection Package Power Dissipation	Power Supply 5 Storage Temperature 5 ESD Protection Human Body Model 7 Package Power Dissipation 6 Peak Current from Drain to Source 7 For no more than 20 µs with 1% duty cycle 7 For no more than 50 µs with 1% duty cycle 7 For no more than	Power SupplyStorage Temperature65ESD ProtectionHuman Body Model2000Package Power DissipationPeak Current from Drain to SourceFor no more than 20 µs with 1% duty cycleFor no more than 50 µs with 1% duty cycle	Power SupplyStorage Temperature65ESD ProtectionHuman Body Model2000Package Power DissipationPeak Current from Drain to SourceFor no more than 20 µs with 1% duty cycleFor no more than 50 µs with 1% duty cycle	Power Supply7Storage Temperature65150ESD ProtectionHuman Body Model2000Package Power Dissipation0.4Peak Current from Drain to SourceFor no more than 20 µs with 1% duty cyclePower Dissipation12.5

only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

 T_A = -40 °C to 85 °C (unless otherwise stated)

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V _{DD}	Power Supply Voltage	-40 °C to 85 °C	2.5		5.5	V
1	Power Supply Current (PIN 1)	when OFF			1	μA
I _{DD}		when ON, No load			10	μA
	Static Drain to Source	$V_{DD} = 5 V, V_D = 1.05 V, V_{DD} - V_D = 4.0 V, R_L = 0.5 \Omega$		20	22	mΩ
	ON Resistance, T _A = 25°C	V_{DD} = 3.3 V, V_{D} = 1.05 V, V_{DD} - V_{D} = 2.3 V, R_{L} = 0.5 Ω		27.5	29	mΩ
RDS _{ON}	Static Drain to Source	$V_{DD} = 5 V, V_D = 1.05 V, V_{DD} - V_D = 4.0 V, R_L = 0.5 \Omega$		23.5	25	mΩ
ND3 _{ON}	ON Resistance, T _A = 70°C	V_{DD} = 3.3 V, V_{D} = 1.05 V, V_{DD} - V_{D} = 2.3 V, R_{L} = 0.5 Ω		31	33	mΩ
	Static Drain to Source	$V_{DD} = 5 V, V_D = 1.05 V, V_{DD} - V_D = 4.0 V, R_L = 0.5 \Omega$		24.5	26	mΩ
	ON Resistance, T _A = 85°C	V_{DD} = 3.3 V, V_{D} = 1.05 V, V_{DD} - V_{D} = 2.3 V, R_{L} = 0.5 Ω		33	35	mΩ
IDS	Operating Current	V _D = 0.85 V to 3.3 V			2.0	А
V _D	Drain Voltage		0.85		V _{DD} - 1.5	V
T	ON Delay Time	50% ON to 10% V _S , Internal Logic Delay, V _{DD} = 5 V, V _D = 1.05 V, Tune Cap = 0.1 nF		12	15	μs
T _{ON_} Delay		50% ON to 10% V _S , Internal Logic Delay, V _{DD} = 5 V, V _D = 1.05 V, Tune Cap = 0.5 nF		32	35	μs

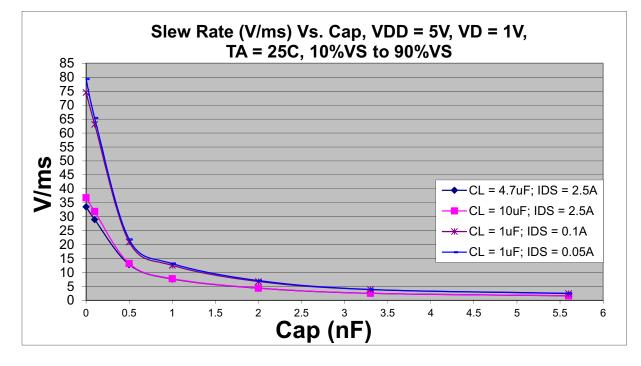


T_A = -40 °C to 85 °C (unless otherwise stated)

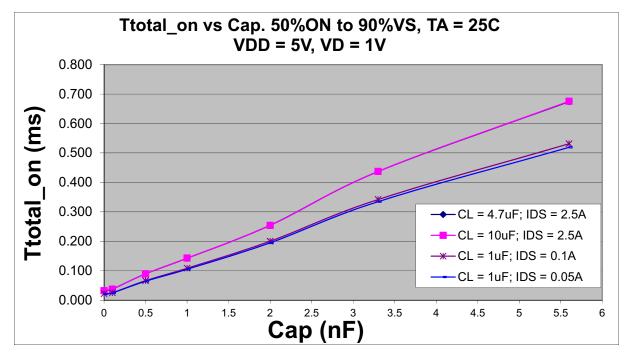
Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
		50% ON to 90% V _S	Configurable			
		50% ON to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 1 μ F, Current Load = 50 mA, Tune Cap = 0.1 nF		32	39	μs
T _{Total_ON}	Total Turn On Time	50% ON to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 1 μ F, Current Load = 100 mA, Tune Cap = 0.1 nF		32	39	μs
		50% ON to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 4.7 μ F, Current Load = 2.5 A, Tune Cap = 0.5 nF		102	123	μs
		50% ON to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 10 μ F, Current Load = 2.5 A, Tune Cap = 0.5 nF		102	123	μs
		10% V _S to 90% V _S		Config	urable	
		10% V _S to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 1 μ F, Current Load = 50 mA, Tune Cap = 0.1 nF		65	78	V/ms
T _{SLEWRATE}	Slew Rate	10% V _S to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 1 μ F, Current Load = 100 mA, Tune Cap = 0.1 nF		65	78	V/ms
		10% V _S to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 4.7 μ F, Current Load = 2.5 A, Tune Cap = 0.5 nF		13	16	V/ms
		10% V _S to 90% V _S , V _{DD} = 5 V, V _D = 1.0 V, C _L = 10 μ F, Current Load = 2.5 A, Tune Cap = 0.5 nF		13.5	16.5	V/ms
CAP _{SOURCE}	Source Cap	Source to GND			10	μF
R _{DIS}	Discharge Resistance		100	150	300	Ω
ON_V_{IH}	High Input Voltage on ON pin		0.85		V _{DD}	V
ON_V_{IL}	Low Input Voltage on ON pin		-0.3	0	0.3	V
T _{OFF_Delay}	OFF Delay Time	50% ON to V _S Fall, C _L = 10 μ F, R _L = 20 Ω , V _{DD} = 5 V, V _D = 1.0 V, No Tune CAP		120	150	μs
THERM_OFF	Thermal Protection Shutoff	Programmable, automatic shutoff temperature		125		°C
THER- M_OFF_ACC	Thermal Sensor Accuracy				±20	%
THERM_DT	Thermal Disable Time	Thermal sensor disable for the ON rising edge to $100 \ \mu s$. Prevent therm shutdown from inrush current			100	μs



Tune Cap vs Slew Rate

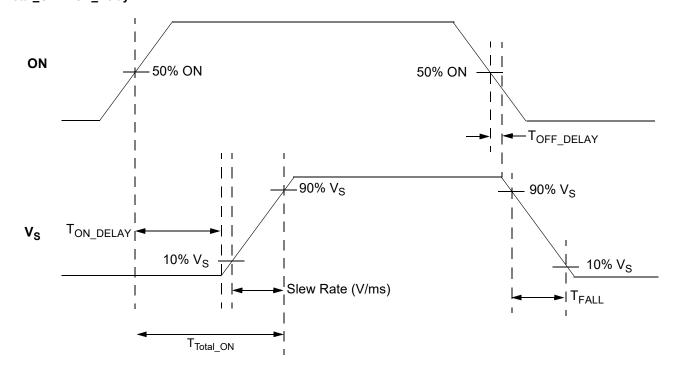


Tune Cap vs Ttotal_on



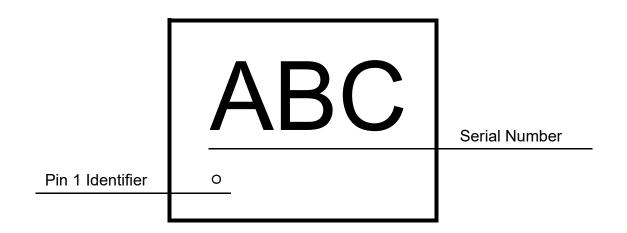


 T_{Total_ON} , T_{ON_Delay} and Slew Rate Measurement (TBD)



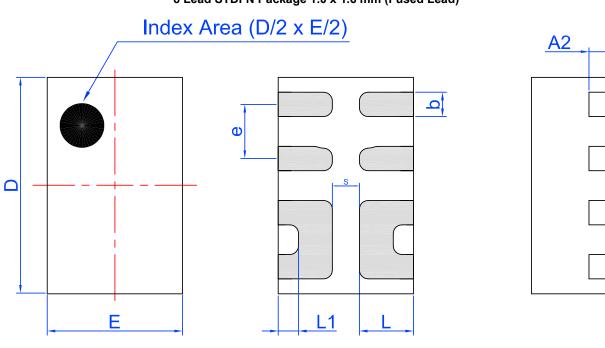


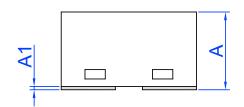
Package Top Marking System Definition





Package Drawing and Dimensions





Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	1.55	1.60	1.65
A1	0.005	-	0.060	E	0.95	1.00	1.05
A2	0.10	0.15	0.20	L	0.35	0.40	0.45
b	0.13	0.18	0.23	L1	0.10	0.15	0.20
е	().40 BSC	,	S	(0.2 REF	

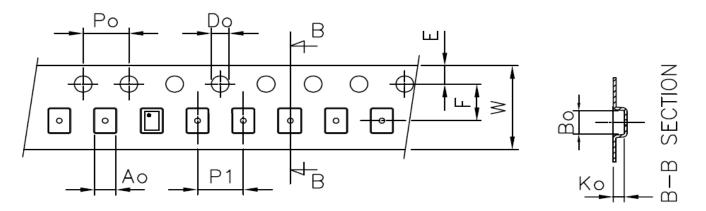


Tape and Reel Specifications

Bookaga	# of	Nominal Max U		Units Reel &		Leader (min)		Trailer (min)		Таре	Part
Package Type	# of Pins	Package Size [mm]	per Reel	per Box	Hub Size [mm]	Pockets	Length [mm]	Pockets	Length [mm]	Width [mm]	Pitch [mm]
STDFN 8L 1x1.6mm 0.4P FC Green		1.0 x 1.6 x 0.55	3,000	3,000	178 / 60	100	400	100	400	8	4

Carrier Tape Drawing and Dimensions

Package Type	PocketBTM Length	PocketBTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge		Tape Width
	A0	В0	K0	P0	P1	D0	E	F	w
STDFN 8L 1x1.6mm 0.4P FC Green	1.12	1.72	0.7	4	4	1.55	1.75	3.5	8



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 0.88 mm³ (nominal). More information can be found at www.jedec.org.

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